

SPECIFICATIONS FOR LCD MODULE

CUSTOMER	
MODEL	SC1602013-V01
CUSTOMER APPROVED	

APPROVED BY	CHECKED BY	ORGANIZED BY
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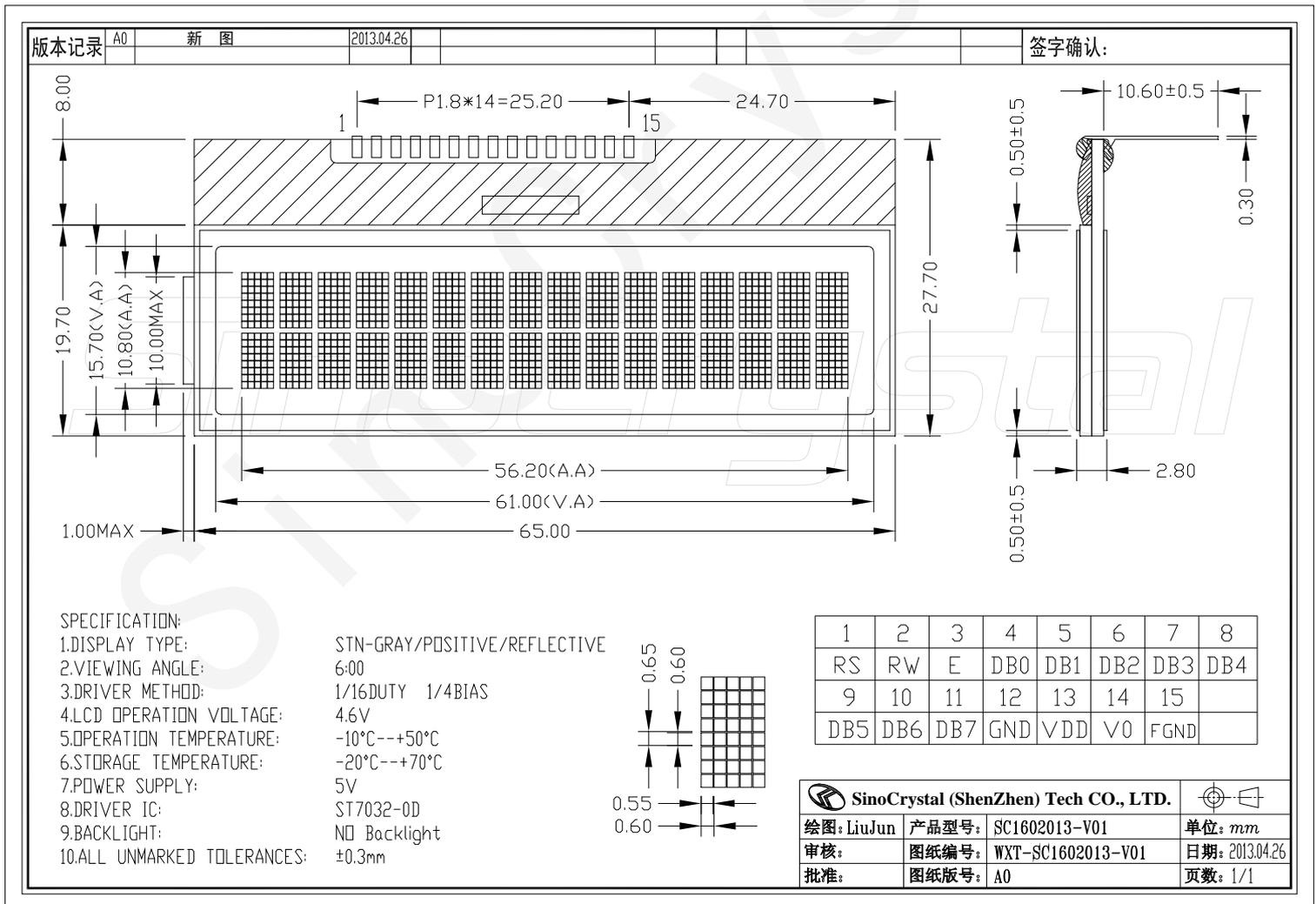
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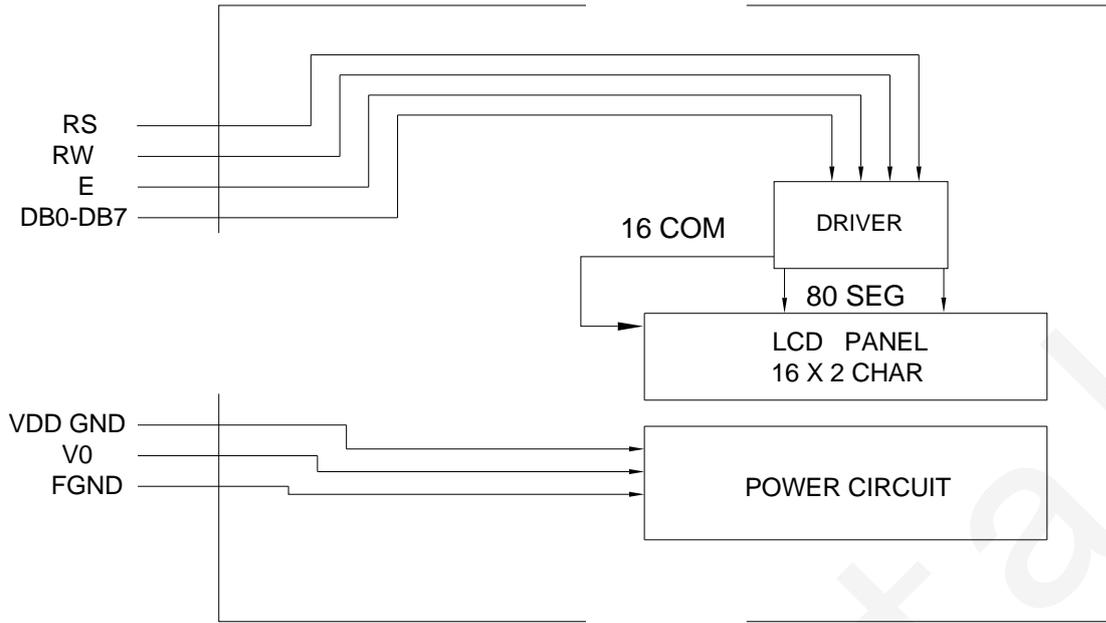
1. PHYSICAL DATA

ITEM	STANDARD VALUE	UNIT
NUMBER OF CHARACTER	16×2	Mm
MODULE DIMENSION	65.0×27.7×10.6(MAX)	Mm
VIEWING AREA	61.0×15.7	Mm
DOT SIZE	0.55×0.65	Mm
DOT PITCH	0.60×0.65	Mm
LCD TYPE	STN/GRAY/POSITIVE/REFLECTIVE	
DUTY	1/16	
VIEWING DIRECTION	6:00	o'clock
BACK LIGHT TYPE	NO BACKLIGHT	
BACK LIGHT COLOR		
APPROX. WEIGHT	TBD	G

2. EXTERNAL DIMENSIONS



3. BLOCK DIAGRAM



4. INTERFACE PIN CONNECTIONS

Pin No.	Symbol	Level	Description
1	RS	H/L	Register selection input H : Indicate that DB0 to DB7 are display data. L : Indicate that DB0 to DB7 are control data
2	RW	H/L	Read or Write signal 0 : Write 1 : Read
3	E	H/L	Enable signal
4-11	DB0-DB7	H/L	8-bit bi-directional data bus
12	GND	--	Gound
13	VDD	--	Supply voltage for logic
14	V0	--	Supply voltage for LCD
15	FGND	--	Frame Ground

5. ABSOLUTE MAXIMUM RATINGS

(1) Electrical Absolute Ratings

Item	Symbol	Min.	Max.	Unit	Note
Power Supply for Logic	VDD	-0.3	6.0	Volt	Note 1
Power Supply for LCD	V _{LCD}	-0.3	7.0	Volt	
Input Voltage	V _I	-0.3	VDD	Volt	
Current for LED backlight	I _{LED}	-	-	mA	No Backlight

Note 1: Operator should be grounded during handling LCM

(2) Environmental Absolute Maximum Ratings

Item	Normal Temperature				Wide Temperature			
	Operating		Storage		Operating		Storage	
	Min.	Max,	Min.	Max,	Min.	Max,	Min.	Max,
Ambient Temperature	0°C	+50°C	-10°C	+60°C	-10°C	+50°C	-20°C	+70°C
Humidity(without condensation)	Note 2,4		Note 3,5		Note 4,5		Note 4,6	

Note 2 $T_a \leq 50^\circ\text{C}$: 80% RH max

$T_a > 50^\circ\text{C}$: Absolute humidity must be lower than the humidity of 85%RH at 50°C

Note 3 T_a at -20°C will be <48hrs at 70°C will be <120hrs when humidity is higher than 75%.

Note 4 Background color changes slightly depending on ambient temperature. This phenomenon is reversible.

Note 5 $T_a \leq 70^\circ\text{C}$: 75RH max

$T_a > 70^\circ\text{C}$: absolute humidity must be lower than the humidity of 75%RH at 70°C

Note 6 T_a at -20°C will be <48hrs, at 80°C will be <120hrs when humidity is higher than 75%.

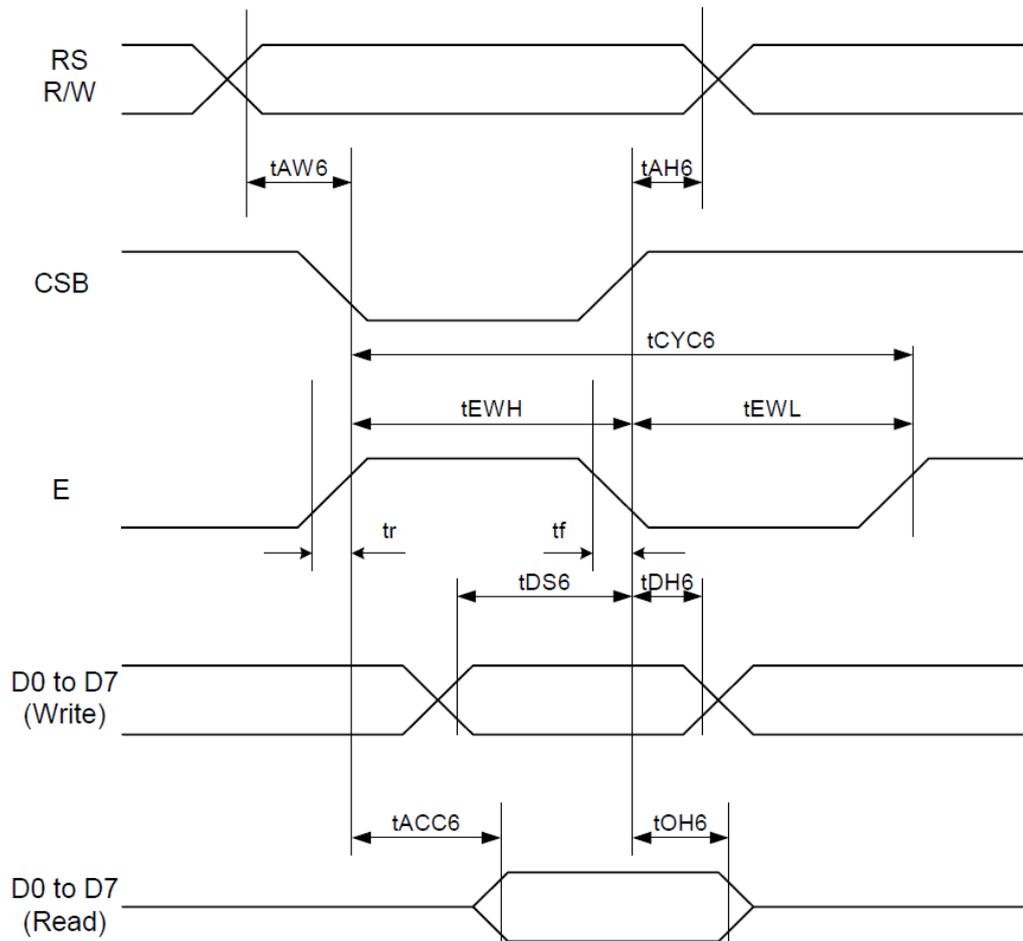
6. ELECTRICAL CHARACTERISTICS

DC Characteristics

(GND=0V, VDD=5V, Ta=25°C)

Item	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Power Supply for Logic	VDD		4.5	-	5.5	Volt
Input Voltage	V _{IH}		2.7	-	VDD	Volt
	V _{IL}		-0.3	-	0.8	Volt
Output Voltage	V _{OH}	I _{OUT} =-1mA	3.8	-	VDD	Volt
	V _{OL}	I _{OUT} =1mA	-	-	0.8	Volt
LCM Recommend LCD Module Driving Voltage	V _{LCD}	T _a =0°C	-	-	-	Volt
		T _a =25°C	-	4.6	-	
		T _a =50°C	-	-	-	
Power Supply Current for LCM	I _{DD} (BL OFF)	T _a =25°C	-	-	2	mA
	I _{DD} (BL ON)	-	No Backlight			
Power Supply for LED Backlight	V _{BLA} - V _{BLK}	T _a =25°C				

AC Characteristics



($T_a = 25^\circ\text{C}$)

Item	Signal	Symbol	Condition	VDD=2.7 to 4.5V Rating		VDD=4.5 to 5.5V Rating		Units
				Min.	Max.	Min.	Max.	
Address hold time	RS	t_{AH6}	—	20	-	20	-	ns
Address setup time	RS	t_{AW6}		20	-	20	-	
System cycle time	RS	t_{CYC6}	—	400	-	280	-	ns
Data setup time	D0 to D7	t_{DS6}	—	100	-	80	-	ns
Data hold time	D0 to D7	t_{DH6}		40	-	20	-	
Access time	D0 to D7	t_{ACC6}	CL = 100 pF	-	500	-	400	ns
Output disable time	D0 to D7	t_{OH6}		300	-	150	-	
Enable Rise/Fall time	E	t_r, t_f	—	-	20	-	20	ns
Enable H pulse time	E	t_{EWH}	—	200	-	120	-	ns
Enable L pulse time	E	t_{EWL}	—	150	-	130	-	ns

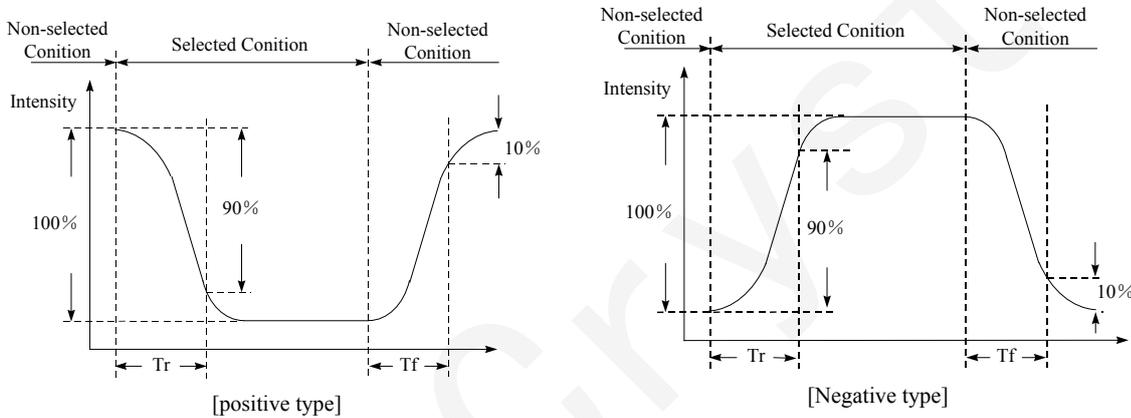
Note: All timing is specified using 20% and 80% of V_{DD} as the reference.

Note: CSB have been connected to GND

7. ELECTRO-OPTICAL CHARACTERISTICS

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	note
Viewing angle range	θ_f (12 o'clock)	When $Cr \geq 1.1$	---	40	---	Degree	Note 2 Note 3 Note 4
	θ_b (6 o'clock)		---	45	---		
	θ_l (9 o'clock)		---	30	---		
	θ_r (3 o'clock)		---	30	---		
Rise Time	T_r	$V_0-GND=4.6V$ $T_a=25^\circ C$		112		mS	Note 1
Fall Time	T_f			250			
Contrast	Cr		---	5.4	---		

[Note 1] Definition of Response Time (T_r , T_f)

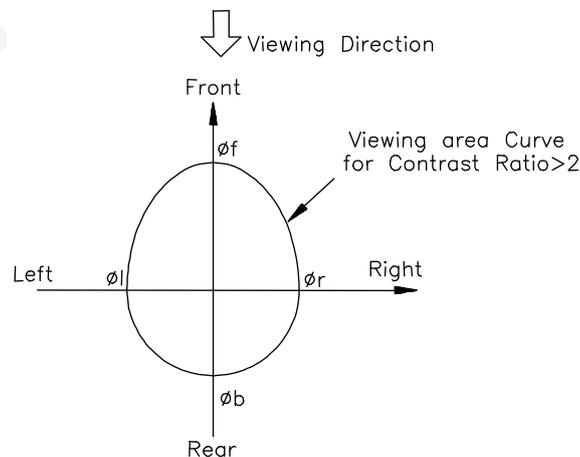


Conditions:

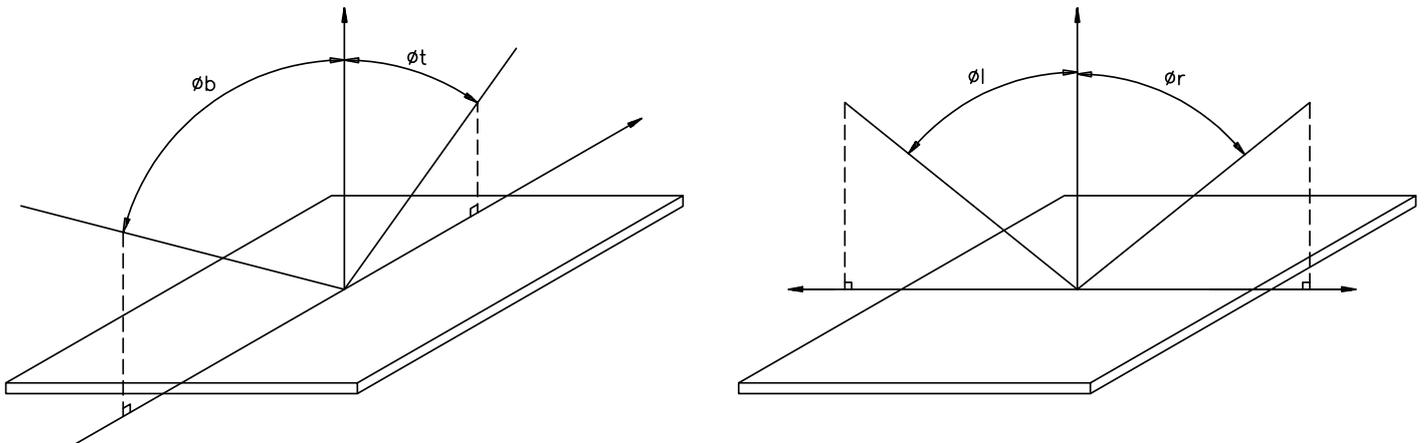
Operating Voltage : V_{op}
Frame Frequency : 64 Hz

Viewing Angle (θ , φ): 0° , 0°
Driving Wave form : 1/N duty, 1/a bias

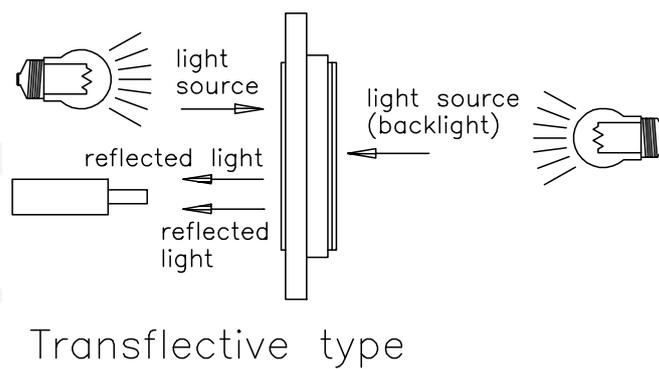
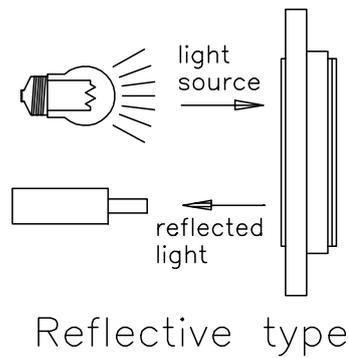
[Note 2] Definition of Viewing Direction



[Note 3] Definition of viewing angle



[Note 4] Description of Measuring Equipment



8. OPERATING PRINCIPLES & METHODS

Command Table

(ST7032 support 2 command mode, SC1602013 is Normal mode, EXT have been connected to VDD)

➤ **instruction table at “Normal mode”**

(When “EXT” option pin connect to VDD, the instruction set follow below table)

Instruction	Instruction Code										Description	Instruction Execution Time		
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		OSC=380KHz	OSC=540kHz	OSC=700KHz
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM. and set DDRAM address to "00H" from AC	1.08 ms	0.76 ms	0.59 ms
Return Home	0	0	0	0	0	0	0	0	1	x	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.08 ms	0.76 ms	0.59 ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.	26.3 us	18.5 us	14.3 us
Display ON/OFF	0	0	0	0	0	0	1	D	C	B	D=1:entire display on C=1:cursor on B=1:cursor position on	26.3 us	18.5 us	14.3 us
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	x	x	S/C and R/L: Set cursor moving and display shift control bit, and the direction, without changing DDRAM data.	26.3 us	18.5 us	14.3 us
Function Set	0	0	0	0	1	DL	N	x	x	x	DL: interface data is 8/4 bits N: number of line is 2/1	26.3 us	18.5 us	14.3 us
Set CGRAM	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter	26.3 us	18.5 us	14.3 us
Set DDRAM address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter	26.3 us	18.5 us	14.3 us
Read Busy flag and address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0	0	0
Write data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM)	26.3 us	18.5 us	14.3 us
Read data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM)	26.3 us	18.5 us	14.3 us

Note:

Be sure the ST7032 is not in the busy state (BF = 0) before sending an instruction from the MPU to the ST7032. If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself. Refer to Instruction Table for the list of each instruction execution time.

NOTE: For more detail information, please refer to the ST7032’s specification.

9. Display Data RAM (DDRAM)

Display data RAM (DDRAM) stores display data represented in 8-bit character codes. Its extended capacity is 80 x 8 bits, or 80 characters. The area in display data RAM (DDRAM) that is not used for display can be used as general data RAM. See Figure 7 for the relationships between DDRAM addresses and positions on the liquid crystal display.

The DDRAM address (A_{DD}) is set in the address counter (AC) as hexadecimal.

Display Position	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
DDRAM Address	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F
	40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F
For Shift Left	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F	10
	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F	50
For Shift Right	27	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E
	67	40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E

NOTE: For more detail information, please refer to the ST7032's specification.

Product Number	OPR1	OPR2	Support Character
ST7032-0D	1	0	English/Japan/European

ST7032-0D (ITO option OPR1=1, OPR2=0)

b7-b4 b3-b0	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111	
0000	Replaced By CGRAM Pattern	À	Á	Â	Ã	Ä	Å	Æ	Ç	È	É	Ê	Ë	Ì	Í	Î	
0001		Ï	Ð	Ñ	Ò	Ó	Ô	Õ	Ö	×	Ø	Ù	Ú	Û	Ü	Ý	
0010		à	á	â	ã	ä	å	æ	ç	è	é	ê	ë	ì	í	î	ï
0011		ð	ñ	ò	ó	ô	õ	ö	×	ø	ù	ú	û	ü	ý	ÿ	
0100																	
0101																	
0110																	
0111																	
1000																	
1001																	
1010																	
1011																	
1100																	
1101																	
1110																	
1111																	

10.RELIABILITY

Environmental Test				
No.	Test Item	Content of Test	Test Condition	Applicable Standard
1	High temperature storage	Endurance test applying the high storage temperature for a long time.	70 °C 200 hrs	-----
2	Low temperature storage	Endurance test applying the low storage temperature for a long time.	-20 °C 200 hrs	-----
3	High temperature operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	50 °C 200 hrs	-----
4	Low temperature operation	Endurance test applying the electric stress under low temperature for a long time.	-10 °C 200 hrs	-----
5	High temperature / Humidity storage	Endurance test applying the high temperature and high humidity storage for a long time.	60 °C , 90 %RH 96 hrs	MIL-202E-103B JIS-C5023
6	High temperature / Humidity operation	Endurance test applying the electric stress (Voltage & Current) and temperature / humidity stress to the element for a long time.	50 °C , 90 %RH 96 hrs	MIL-202E-103B JIS-C5023
7	Temperature cycle	Endurance test applying the low and high temperature cycle. $\begin{array}{ccccc} -10^{\circ}\text{C} & \rightleftharpoons & 25^{\circ}\text{C} & \rightleftharpoons & 50^{\circ}\text{C} \\ \leftarrow 30\text{min} & & 5\text{min} & & 30\text{min} \rightarrow \\ & & \text{1 cycle} & & \end{array}$	-10°C / 50°C 10 cycles	-----
Mechanical Test				
8	Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz → 1.5mmp-p 22~500Hz → 1.5G Total 0.5hrs	MIL-202E-201A JIS-C5025 JIS-C7022-A-10
9	Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G half sign wave 11 msedc 3 times of each direction	MIL-202E-213B
10	Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air.	115 mbar 40 hrs	MIL-202E-105C
Others				
11	Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V , RS=1.5 kΩ CS=100 pF 10 time	MIL-883B-3015.1
Inspection after test: Inspection after 2~4 hours storage at room temperature ,the sample shall be free from defects: <ol style="list-style-type: none"> Air bubble in the LCD. Sealleak Non-display. Missing segments. Glass crack. Current Idd is twice higher than initial value. 				

11.QUALITY GUARANTEE

No	Item	Criteria
1	inclusions (black spot, white spot, dust)	(1)round type diameter mm(a*) no of defect* $a \leq 0.20$ neglect $0.20 < a \leq 0.35$ 5max $0.35 < a$ none (2)linear type length mm(l) width mm(W) no. of defect na $W \leq 0.03$ neglect $1 \leq 3$ $0.03 < W \leq 0.08$ 6 $3 < l$ $0.08 < W$ none
2	scratch	1.scratch on protective film is permitted. 2.scratch on polarizer shall be as follow: (1)round type diameter mm(a*) no of defect $a \leq 0.15$ neglect $0.15 < a \leq 0.20$ 2 max $0.20 < a$ none (2)linear type be judged by 1.-(2) linear type
3	dent	diameter < 1.5mm
4	bubble	not exceeding 0.5mm average diameter is acceptable between glass and polarizing film
5	pin hole	$(a+b)/2 \leq 0.15\text{mm}$ maximum number: ignored $0.15 < (a+b)/2 \leq 0.20\text{mm}$ maximum number: 10
6	dot width	design width $\pm 15\%$
7	dot defect	$(a+b)/2 \leq 0.20\text{mm}$ maximum number: ignored $0.20 < (a+b)/2 \leq 0.30\text{mm}$ maximum number: 5 x=width
8	contrast irregularity(spot)	diameter spec no of defect $a \leq 0.50\text{mm}$ neglect $0.50 < a \leq 0.75$ 5 $0.75 < a \leq 1.00$ 3 $1.00 < a$ none
9	color tone and uniformity	obvious uneven color is not permitted

12. USING LCD MODULES

12-1. Liquid Crystal Display Modules

LCD is composed of glass and polarizer. Pay attention to the following items when handling.

(1) Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

(2) Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.).

(3) N-hexane is recommended for cleaning the adhesives used to attach front/rear polarizers and reflectors made of organic substances which will be damaged by chemicals such as acetone, toluene, ethanol and isopropylalcohol.

(4) When the display surface becomes dusty, wipe gently with absorbent cotton or other soft material like chamois soaked in petroleum benzin. Do not scrub hard to avoid damaging the display surface.

(5) Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading.

(6) Avoid contacting oil and fats.

(7) Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizers. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.

(8) Do not put or attach anything on the display area to avoid leaving marks on.

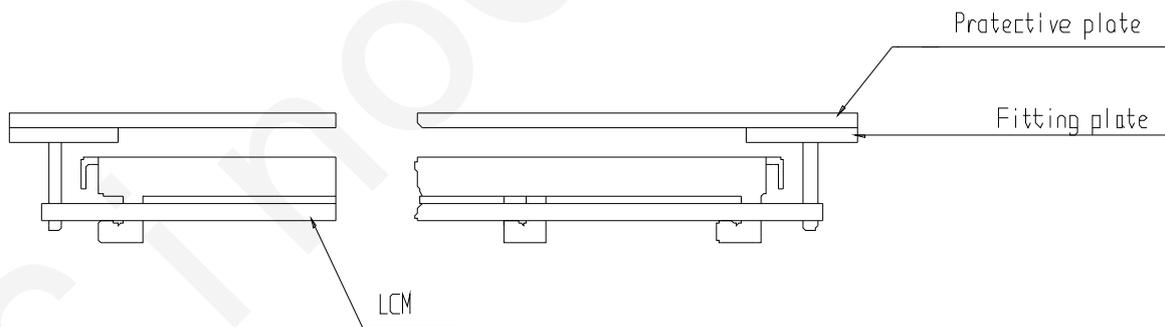
(9) Do not touch the display with bare hands. This will stain the display area and degradate insulation between terminals (some cosmetics are determinated to the polarizers).

(10) As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring.

12-2. Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

(1) Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



(2) When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.

12-3. Precaution for Handling LCD Modules

Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

(1) Do not alter, modify or change the shape of the tab on the metal frame.

(2) Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

(3) Do not damage or modify the pattern writing on the printed circuit board.

(4) Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.

(5) Except for soldering the interface, do not make any alterations or modifications with a soldering iron.

(6) Do not drop, bend or twist LCM.

LCM is easy to be damaged. Please note below and be careful for handling.

Correct handling:

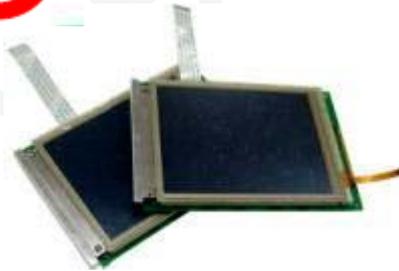


As above picture, please handle with anti-static gloves around LCM edges.

Incorrect handling:



Please don't touch IC directly.



Please don't stack LCM.



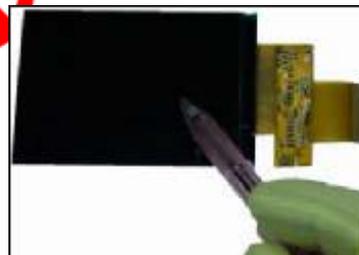
Please don't hold the surface of panel.



Please don't stretch interface of output, such as FPC cable.



Please don't hold the surface of IC.



Please don't operate with sharp stick such as pens.

12-4. Electro-Static Discharge Control

Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC.

- (1) Make certain that you are grounded when handing LCM.
- (2) Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential.
- (3) When soldering the terminal of LCM, make certain the AC power source for the soldering iron does not leak.
- (4) When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
- (5) As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.
- (6) To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended.

12-5. Precaution for soldering to the LCM

- (1) Observe the following when soldering lead wire, connector cable and etc. to the LCM.
 - Soldering iron temperature : $280^{\circ}\text{C} \pm 10^{\circ}\text{C}$.
 - Soldering time : 3-4 sec.
 - Solder : eutectic solder.

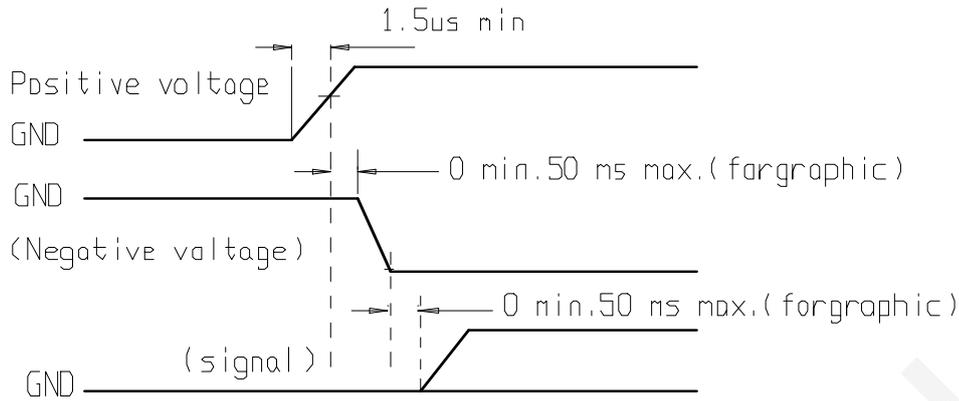
If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.

- (2) When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.

- (3) When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

12-6. Precautions for Operation

- (1) Viewing angle varies with the change of liquid crystal driving voltage (VO). Adjust VO to show the best contrast.
- (2) Driving the LCD in the voltage above the limit shortens its life.
- (3) Response time is greatly delayed at temperature below the operating temperature range. However, this does not mean the LCD will be out of the order. It will recover when it returns to the specified temperature range.
- (4) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- (5) Condensation on terminals can cause an electrochemical reaction disrupting the terminal circuit. Therefore, it must be used under the relative condition of 40°C , 50% RH.
- (6) When turning the power on, input each signal after the positive/negative voltage becomes stable.



12-7. Storage

When storing LCDs as spares for some years, the following precaution are necessary.

(1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for dessicant.

(2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.

(3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped.)

(4) Environmental conditions :

- Do not leave them for more than 168hrs. at 60°C.
- Should not be left for more than 48hrs. at -20°C.

12-8. Safety

(1) It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.

(2) If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

12-9.Return LCM under warranty

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

- Broken LCD glass.
- PCB eyelet's damaged or modified.
- PCB conductors damaged.
- Circuit modified in any way, including addition of components.
- PCB tampered with by grinding, engraving or painting varnish.
- soldering to or modifying the bezel in any manner.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet's, conductors and terminals.